Dual 4-channel analog multiplexer/demultiplexerRev. 8 — 17 November 2011Pro

Product data sheet

#### **General description** 1.

The HEF4052B is a dual 4-channel analog multiplexer/demultiplexer with common channel select logic. Each multiplexer/demultiplexer has four independent inputs/outputs (nY0 to nY3) and a common input/output (nZ). The common channel select logic includes two select inputs (S1 and S2) and an active LOW enable input (E). Both multiplexers/demultiplexers contain four bidirectional analog switches, each with one side connected to an independent input/output (nY0 to nY3) and the other side connected to a common input/output (nZ). With  $\overline{E}$  LOW, one of the four switches is selected (low-impedance ON-state) by S1 and S2. With E HIGH, all switches are in the high-impedance OFF-state, independent of S1 and S2. If break before make is needed, then it is necessary to use the enable input.

V<sub>DD</sub> and V<sub>SS</sub> are the supply voltage connections for the digital control inputs (S1 and S2, and E). The V<sub>DD</sub> to V<sub>SS</sub> range is 3 V to 15 V. The analog inputs/outputs (nY0 to nY3, and nZ) can swing between  $V_{DD}$  as a positive limit and  $V_{EE}$  as a negative limit.  $V_{DD} - V_{EE}$  may not exceed 15 V. Unused inputs must be connected to V<sub>DD</sub>, V<sub>SS</sub>, or another input. For operation as a digital multiplexer/demultiplexer, V<sub>EE</sub> is connected to V<sub>SS</sub> (typically ground).  $V_{EE}$  and  $V_{SS}$  are the supply voltage connections for the switches.

#### Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

#### **Applications** 3.

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating



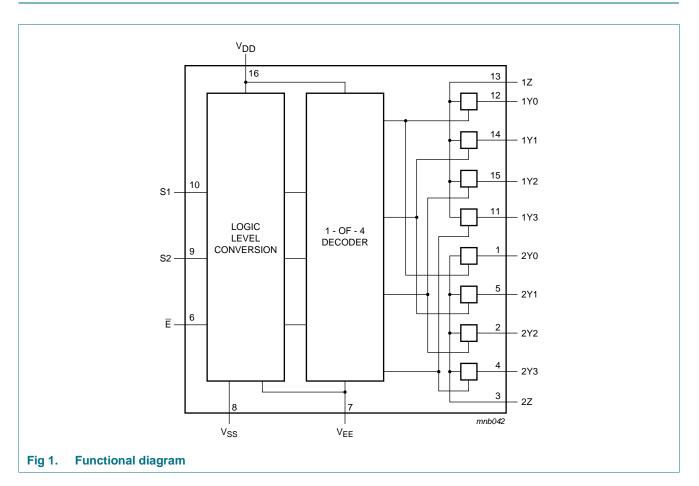
## 4. Ordering information

#### Table 1. Ordering information

All types operate from −40 °C to +125 °C.

Type number	Package		
	Name	Description	Version
HEF4052BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
HEF4052BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
HEF4052BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

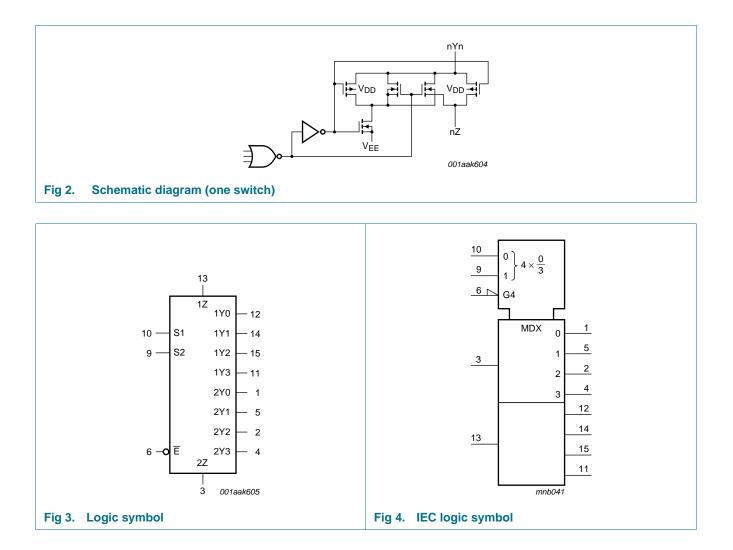
## 5. Functional diagram



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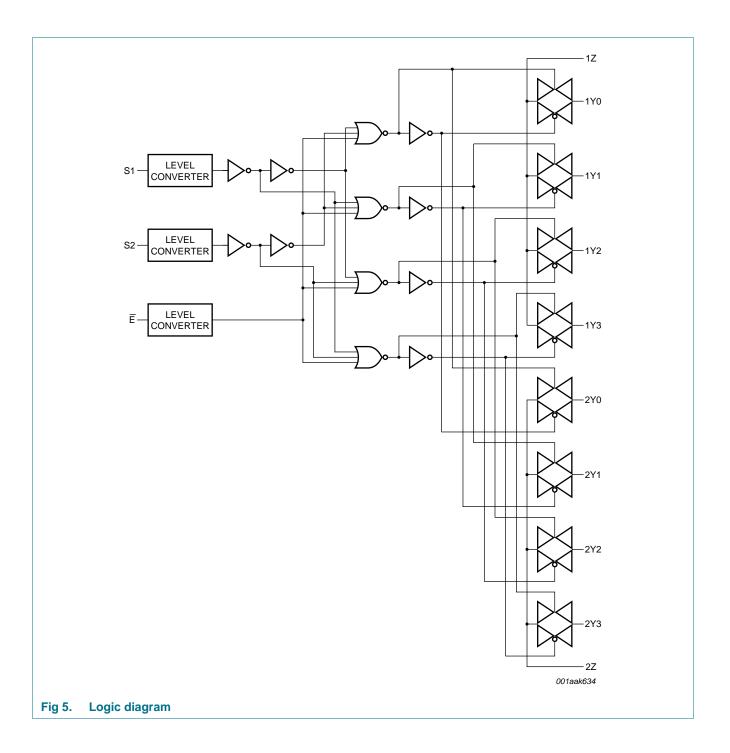
#### Dual 4-channel analog multiplexer/demultiplexer



HEF4052B

3 of 22

## Dual 4-channel analog multiplexer/demultiplexer



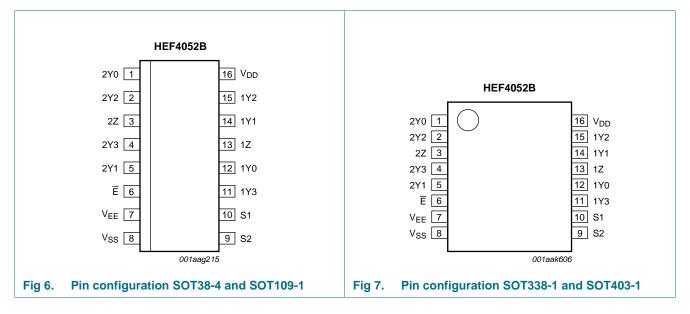
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HEF4052B

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## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 2.         Pin description		
Symbol	Pin	Description
Ē	6	enable input (active LOW)
V <sub>EE</sub>	7	supply voltage
V <sub>SS</sub>	8	ground supply voltage
S1, S2	10, 9	select input
1Y0, 1Y1, 1Y2, 1Y3, 2Y0, 2Y1, 2Y2, 2Y3	12, 14, 15, 11, 1, 5, 2, 4	independent input or output
1Z, 2Z	13, 3	common output or input
V <sub>DD</sub>	16	supply voltage

### 7. Functional description

#### 7.1 Function table

InputChannel onES2S1LLNY0 to nZLLNY1 to nZLHnY2 to nZLHNY3 to nZLXX	Table 3. Fu	nction table <sup>[1]</sup>			
LLNY0 to nZLLNY1 to nZLHnY2 to nZLHNY3 to nZ	Input			Channel on	
LHnY1 to nZLHLnY2 to nZLHHnY3 to nZ	Ē	S2	S1		
LHLnY2 to nZLHHnY3 to nZ	L	L	L	nY0 to nZ	
L H H nY3 to nZ	L	L	Н	nY1 to nZ	
	L	Н	L	nY2 to nZ	
H X X switches off	L	Н	Н	nY3 to nZ	
	Н	Х	Х	switches off	

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

### 8. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 V$  (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+18	V
V <sub>EE</sub>	supply voltage	referenced to V <sub>DD</sub>	<u>[1]</u> –18	+0.5	V
Ι <sub>ΙΚ</sub>	input clamping current	pins Sn and $\overline{E};$ V <sub>I</sub> < –0.5 V or V <sub>I</sub> > V <sub>DD</sub> + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V <sub>DD</sub> + 0.5	V
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+125	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2]		
		DIP16 package	-	750	mW
		SO16 package	-	500	mW
		TSSOP16 package	-	500	mW
Р	power dissipation	per output	-	100	mW

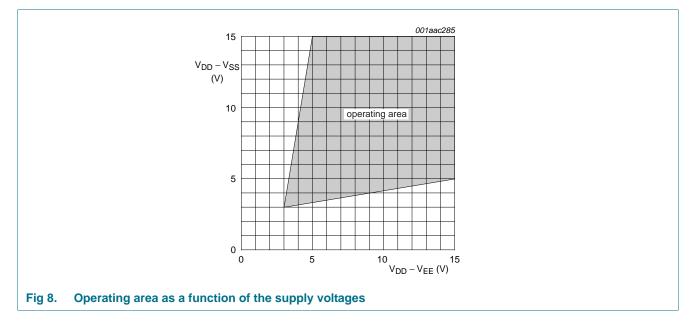
[1] To avoid drawing V<sub>DD</sub> current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V<sub>DD</sub> current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V<sub>DD</sub> or V<sub>EE</sub>.

[2] For DIP16 package: P<sub>tot</sub> derates linearly with 12 mW/K above 70 °C.
 For SO16 package: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.
 For SSOP16 package: P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.

Dual 4-channel analog multiplexer/demultiplexer

## 9. Recommended operating conditions

Recommended operating conditions							
Parameter	Conditions	Min	Тур	Max	Unit		
supply voltage	see Figure 8	3	-	15	V		
input voltage		0	-	$V_{DD}$	V		
ambient temperature	in free air	-40	-	+125	°C		
input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V		
	V <sub>DD</sub> = 10 V	-	-	0.5	μs/V		
	$V_{DD} = 15 V$	-	-	0.08	μs/V		
	Parameter         supply voltage         input voltage         ambient temperature         input transition rise and fall	ParameterConditionssupply voltagesee Figure 8input voltageinput voltageambient temperaturein free airinput transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinsupply voltagesee Figure 83input voltage0ambient temperaturein free air-40input transition rise and fall rate $V_{DD} = 5 V$ - $V_{DD} = 10 V$ -	ParameterConditionsMinTypsupply voltagesee Figure 83-input voltage0-ambient temperaturein free air-40-input transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinTypMaxsupply voltagesee Figure 83-15input voltage0- $V_{DD}$ ambient temperaturein free air-40-+125input transition rise and fall rate $V_{DD} = 5 V$ 3.75 $V_{DD} = 10 V$ 0.5		



## **10. Static characteristics**

#### Table 6. Static characteristics

 $V_{SS} = V_{EE} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	= 25 °C	T <sub>amb</sub> =	85 °C	T <sub>amb</sub> = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>IH</sub> HIGH-level	I <sub>O</sub>   < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V	
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level	I <sub>O</sub>   < 1 μA	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μA

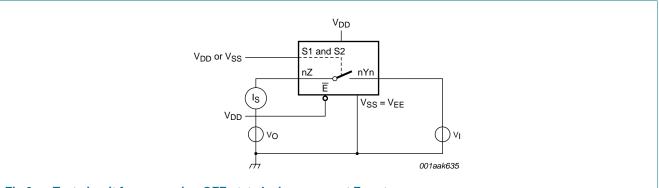
#### Dual 4-channel analog multiplexer/demultiplexer

#### Table 6. Static characteristics ...continued

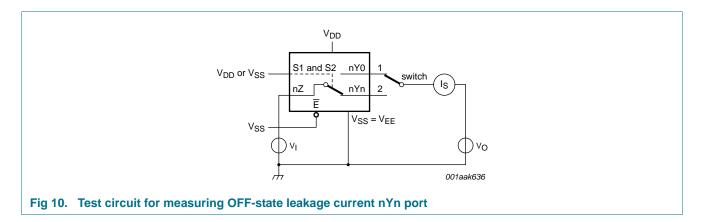
 $V_{SS} = V_{EE} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> =	= 25 °C	T <sub>amb</sub> =	: 85 °C	T <sub>amb</sub> = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I <sub>S(OFF)</sub>	OFF-state leakage current	Z port; all channels OFF; see <u>Figure 9</u>	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see <u>Figure 10</u>	15 V	-	-	-	200	-	-	-	-	nA
I <sub>DD</sub>	supply current	I <sub>O</sub> = 0 A	5 V	-	5	-	5	-	150	-	150	μA
			10 V	-	10	-	10	-	300	-	300	μA
			15 V	-	20	-	20	-	600	-	600	μA
CI	input capacitance	Sn, $\overline{E}$ inputs	-	-	-	-	7.5	-	-	-	-	pF

### 10.1 Test circuits



#### Fig 9. Test circuit for measuring OFF-state leakage current Z port



Dual 4-channel analog multiplexer/demultiplexer

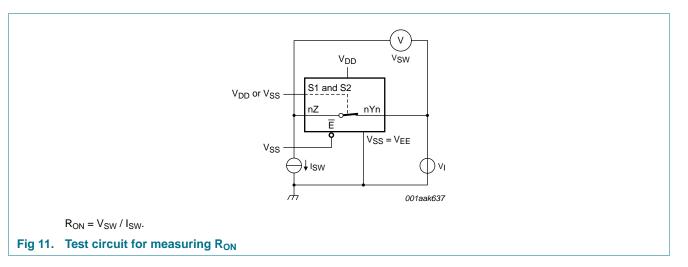
### 10.2 On resistance

#### Table 7. ON resistance

 $T_{amb}=25~^{\circ}\mathrm{C};~I_{SW}=200~\mu A;~V_{SS}=V_{EE}=0~V.$ 

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0 V \text{ to } V_{DD} - V_{EE};$	5 V	350	2500	Ω
		see Figure 11 and Figure 12	10 V	80	245	Ω
			15 V	60	175	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	$V_I = 0 V$ ; see <u>Figure 11</u> and <u>Figure 12</u>	5 V	115	340	Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
	$V_I = V_{DD} - V_{EE};$		5 V	120	365	Ω
		see Figure 11 and Figure 12	10 V	65	200	Ω
			15 V	50	155	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 V$ to $V_{DD} - V_{EE}$ ; see Figure 11	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

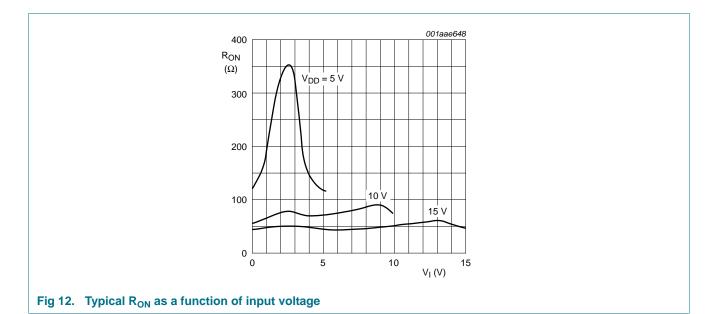
#### 10.2.1 On resistance waveform and test circuit



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#### Dual 4-channel analog multiplexer/demultiplexer



## **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

 $T_{amb} = 25 \ ^{\circ}C; V_{SS} = V_{EE} = 0 V;$  for test circuit see Figure 16.

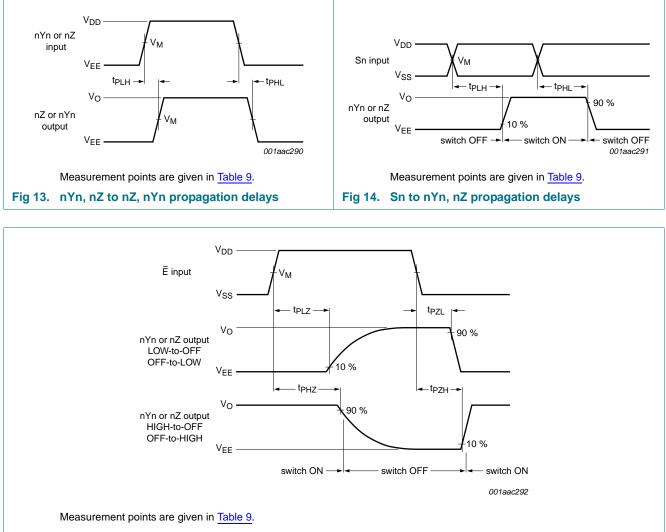
Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW propagation delay	nYn, nZ to nZ, nYn; see Figure 13	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to nYn, nZ; see Figure 14	5 V	150	305	ns
			10 V	65	135	ns
			15 V	50	100	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	Yn, nZ to nZ, nYn; see Figure 13	5 V	10	20	ns
			10 V	5	10	ns
			15 V	5	10	ns
		Sn to nYn, nZ; see Figure 14	5 V	150	300	ns
			10 V	75	150	ns
			15 V	50	100	ns
t <sub>PHZ</sub>	HIGH to OFF-state	E to nYn, nZ; see Figure 15	5 V	95	190	ns
	propagation delay		10 V	90	180	ns
			15 V	85	180	ns
t <sub>PZH</sub>	OFF-state to HIGH	E to nYn, nZ; see Figure 15	5 V	130	260	ns
	propagation delay		10 V	55	115	ns
			15 V	45	85	ns
t <sub>PLZ</sub>	LOW to OFF-state	E to nYn, nZ; see Figure 15	5 V	100	205	ns
	propagation delay		10 V	90	180	ns
			15 V	90	180	ns

#### Dual 4-channel analog multiplexer/demultiplexer

$T_{amb} = 25$	$T_{amb} = 25 \ ^{\circ}C; V_{SS} = V_{EE} = 0 \ V; for test circuit see Figure 16.$										
Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit					
	OFF-state to LOW	E to nYn, nZ; see Figure 15	5 V	120	240	ns					
	propagation delay		10 V	50	100	ns					
			15 V	35	75	ns					

#### Table 8. Dynamic characteristics ...continued

11.1 Waveforms and test circuit

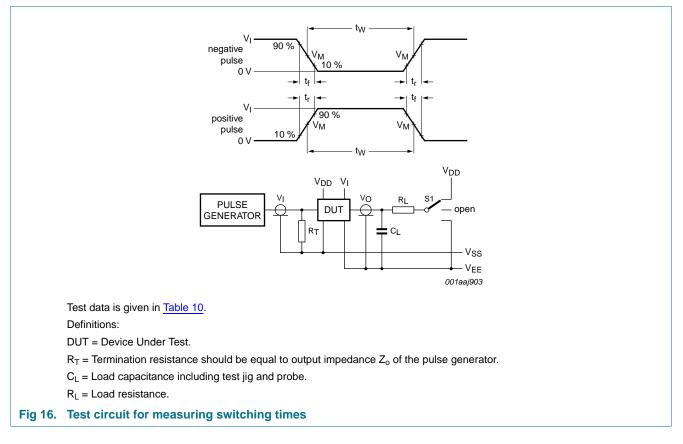


#### Fig 15. Enable and disable times

#### Table 9. Measurement points

Supply voltage	Input	Output
V <sub>DD</sub>	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

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#### Table 10. Test data

Input			Load	.oad S1 position						
nYn, nZ	Sn and $\overline{E}$	t <sub>r</sub> , t <sub>f</sub>	V <sub>M</sub>	CL	RL	t <sub>PHL</sub> [1]	t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>	other
$V_{\text{DD}} \text{ or } V_{\text{EE}}$	$V_{DD}$ or $V_{SS}$	≤ 20 ns	0.5V <sub>DD</sub>	50 pF	10 kΩ	$V_{DD}$ or $V_{EE}$	V <sub>EE</sub>	V <sub>EE</sub>	V <sub>DD</sub>	V <sub>EE</sub>

[1] For nYn to nZ propagation delays use  $V_{EE}$ . For Sn to nYn or nZ propagation delays use  $V_{DD}$ .

Dual 4-channel analog multiplexer/demultiplexer

### 11.2 Additional dynamic parameters

#### Table 11. Additional dynamic characteristics

 $V_{\text{SS}} = V_{EE} = 0$  V;  $T_{amb} = 25$  °C.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
THD	total harmonic distortion	see Figure 17; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1 \text{ kHz}$	5 V	<u>[1]</u> 0.25	-	%
			10 V	<u>[1]</u> 0.04	-	%
			15 V	<u>[1]</u> 0.04	-	%
f <sub>(-3dB)</sub>	–3 dB frequency response	see Figure 18; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; channel ON; $V_I = 0.5V_{DD}$ (p-p)	5 V	<u>11</u> 13	-	MHz
			10 V	<u>[1]</u> 40	-	MHz
			15 V	<u>[1]</u> 70	-	MHz
$\alpha_{iso}$	isolation (OFF-state)	see Figure 19; $f_i = 1 \text{ MHz}$ ; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ; channel OFF; $V_I = 0.5V_{DD}$ (p-p)	10 V	<u>[1]</u> –50	-	dB
V <sub>ct</sub>	crosstalk voltage	digital inputs to switch; see Figure 20; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; E or Sn = V <sub>DD</sub> (square-wave)	10 V	50	-	mV
Xtalk	crosstalk	between switches; see <u>Figure 21</u> ; $f_i = 1 \text{ MHz}; R_L = 1 \text{ k}\Omega;$ $V_I = 0.5V_{DD} \text{ (p-p)}$	10 V	[1] –50	-	dB

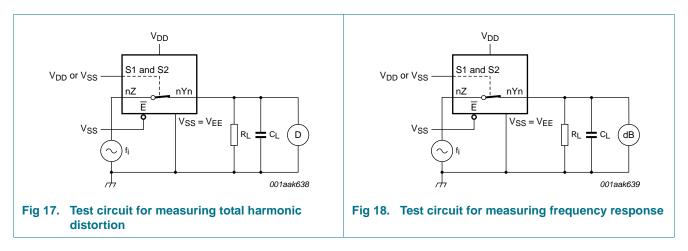
[1]  $f_i$  is biased at 0.5 V<sub>DD</sub>; V<sub>I</sub> = 0.5V<sub>DD</sub> (p-p).

#### Table 12.Dynamic power dissipation PD

 $P_D$  can be calculated from the formulas shown;  $V_{EE} = V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

Symbol	Parameter	V <sub>DD</sub>	Typical formula for $P_D$ ( $\mu$ W)	where:
P <sub>D</sub>	dynamic power dissipation	5 V	$P_D = 1300 \times f_i + \Sigma (f_o \times C_L) \times V_DD^2$	$f_i = input frequency in MHz;$
		10 V	$P_D = 6100 \times f_i + \Sigma (f_o \times C_L) \times V_DD^2$	f <sub>o</sub> = output frequency in MHz;
		15 V	$P_{D} = 15600 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	$C_L$ = output load capacitance in pF;
				V <sub>DD</sub> = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

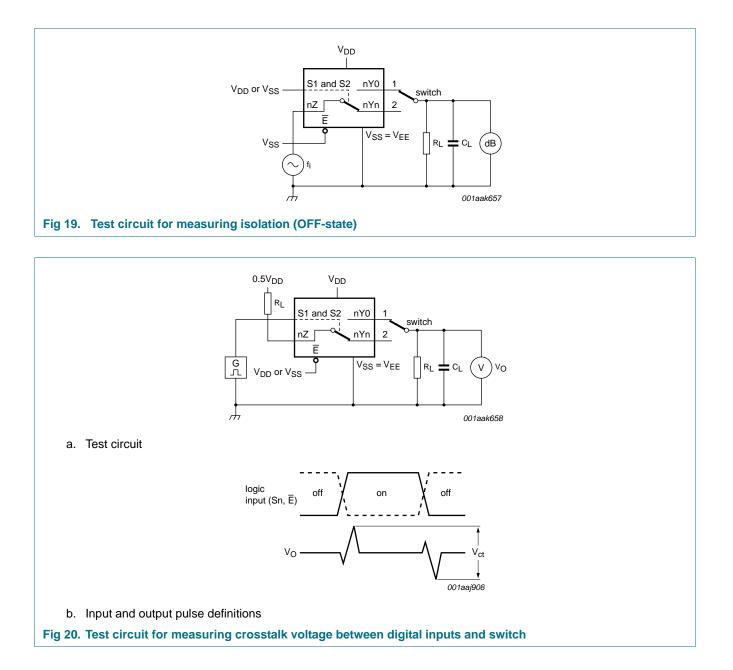




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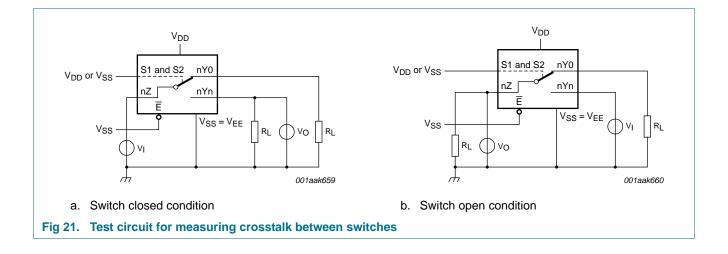
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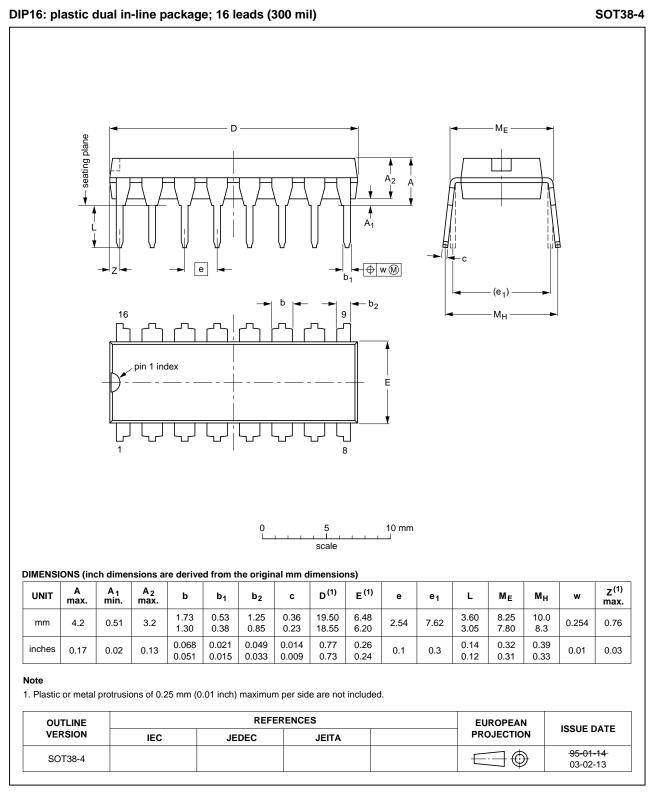
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### Dual 4-channel analog multiplexer/demultiplexer



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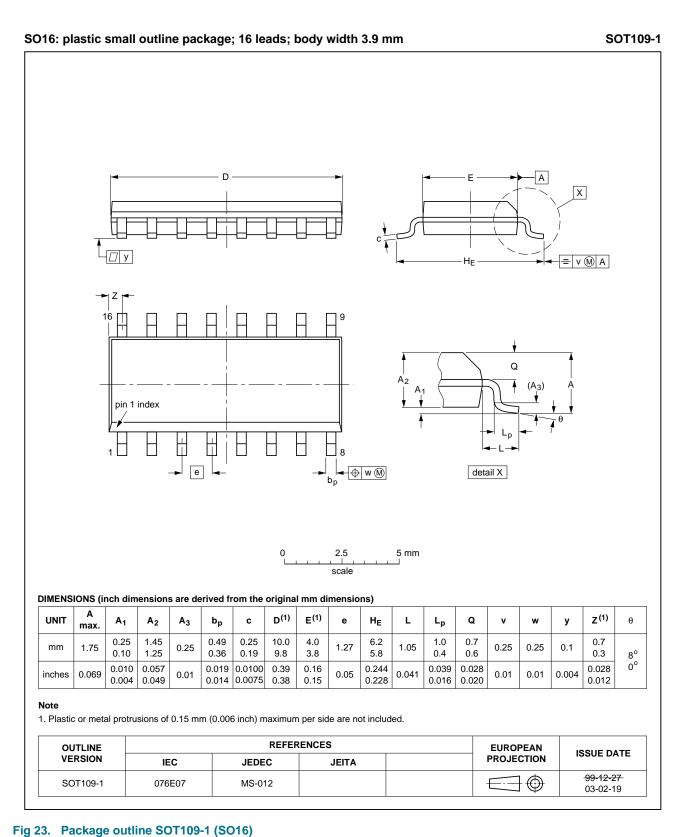
### 12. Package outline



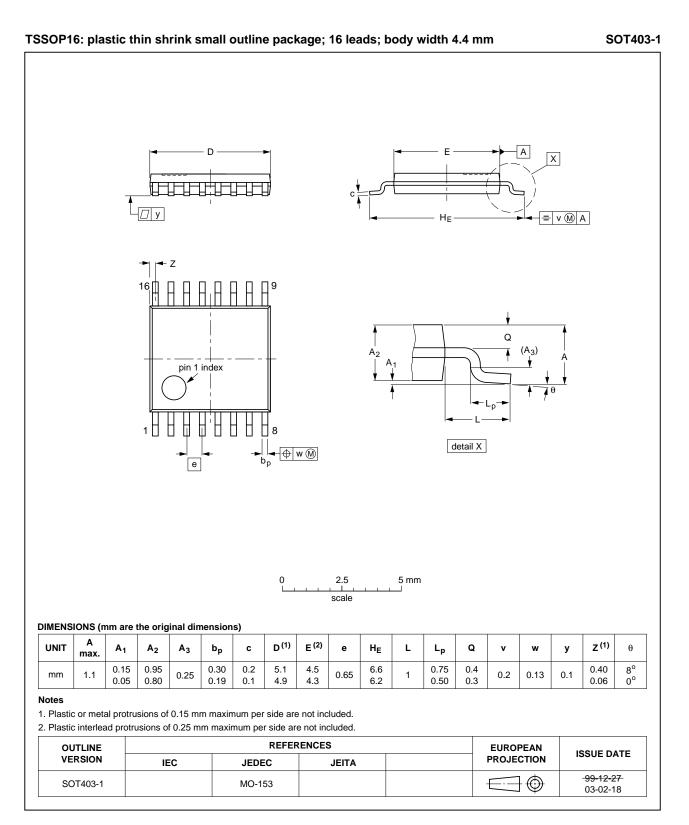
#### Fig 22. Package outline SOT38-4 (DIP16)

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#### Fig 24. Package outline SOT403-1 (TSSOP16)

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## 13. Revision history

Table 13. Revision hi	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4052B v.8	20111117	Product data sheet	-	HEF4052B v.7
Modifications:	<ul> <li>Legal pages</li> </ul>	s updated.		
	<ul> <li>Changes in</li> </ul>	"General description", "Fea	tures and benefits" and	"Applications".
HEF4052B v.7	20100326	Product data sheet	-	HEF4052B v.6
HEF4052B v.6	20100308	Product data sheet	-	HEF4052B v.5
HEF4052B v.5	20091127	Product data sheet	-	HEF4052B v.4
HEF4052B v.4	20090924	Product data sheet	-	HEF4052B_CNV v.3
HEF4052B_CNV v.3	19950101	Product specification	-	HEF4052B_CNV v.2
HEF4052B_CNV v.2	19950101	Product specification	-	-

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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#### Dual 4-channel analog multiplexer/demultiplexer

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### 16. Contents

1	General description 1			
2	Features and benefits 1			
3	Applications 1			
4	Ordering information 2			
5	Functional diagram 2			
6	Pinning information 5			
6.1	Pinning 5			
6.2	Pin description 5			
7	Functional description 6			
7.1	Function table 6			
8	Limiting values			
9	Recommended operating conditions7			
10	Static characteristics 7			
10.1	Test circuits			
10.2	On resistance 9			
10.2.1	On resistance waveform and test circuit 9			
11	Dynamic characteristics 10			
11.1	Waveforms and test circuit			
11.2	Additional dynamic parameters			
11.2.1	Test circuits			
12	Package outline 16			
13	Revision history 19			
14	Legal information 20			
14.1	Data sheet status 20			
14.2	Definitions			
14.3	Disclaimers			
14.4	Trademarks			
15	Contact information 21			
16	Contents			

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